

STAH58095F4C GaN TRANSISTOR

Document Number:
STAH58095F4C
Preliminary Datasheet V1.0

Gallium Nitride 28V 100W, C band RF Power Transistor

Description

The STAH58095F4C is a 100W internally matched, GaN HEMT, designed from 5.0 to 6.0GHz, especially 5G NR or LTE application, as well as either Pulse or CW application. There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

- Typical **CW** performance (on 5.7-5.9GHz fixture with device soldered):

$I_{DQ}=200mA$, $T_c=25\text{ }^\circ\text{C}$

Voltage(V)	Psat(W)	Eff(%>@Psat	Gain @Psat (dB)
28	108-125	60	11-11.4
32	130-150	58	11-11.5
36	150-160	55	11.5-12



Applications and Features

- Suitable for wireless communication infrastructure, wideband amplifier, EMC testing, ISM etc.
- High Efficiency and Linear Gain Operations
- Thermally Enhanced Industry Standard Package
- High Reliability Metallization Process
- Excellent thermal Stability and Excellent Ruggedness
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

1. Set VGS to the pinch-off (VP) voltage, typically -5 V
2. Turn on VDS to nominal supply voltage (28V)
3. Increase VGS until IDS current is attained
4. Apply RF input power to desired level

Turning the device OFF

1. Turn RF power off
2. Reduce VGS down to VP, typically -5 V
3. Reduce VDS down to 0 V
4. Turn off VGS

Figure 1: Pin definitions (Top view)

Because of internal configuration, it must be used as single ended device.

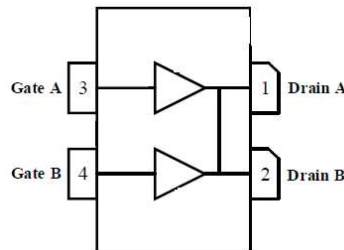


Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	V_{DSS}	150	Vdc
Gate--Source Voltage	V_{GS}	-10,+2	Vdc

STAH58095F4C GaN TRANSISTOR

Document Number:
STAH58095F4C
Preliminary Datasheet V1.0

Operating Voltage	V_{DD}	36	Vdc
Maximum Forward Gate Current @ $T_C = 25^\circ\text{C}$	I_{gmax}	36	mA
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$
Case Operating Temperature	T_C	+150	$^\circ\text{C}$
Operating Junction Temperature(See note 1)	T_J	+225	$^\circ\text{C}$
Total Device Power Dissipation (Derated above 25°C , see note 2)	P_{diss}	150	W

Note: 1. Continuous operation at maximum junction temperature will affect MTTF
2. Bias Conditions should also satisfy the following expression: $P_{diss} < (T_J - T_C) / R_{\theta JC}$ and $T_C = T_{case}$

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_C = 85^\circ\text{C}$, $T_J = 200^\circ\text{C}$, RF CW operation	$R_{\theta JC}$	0.9	C/W

Table 3. Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

DC Characteristics

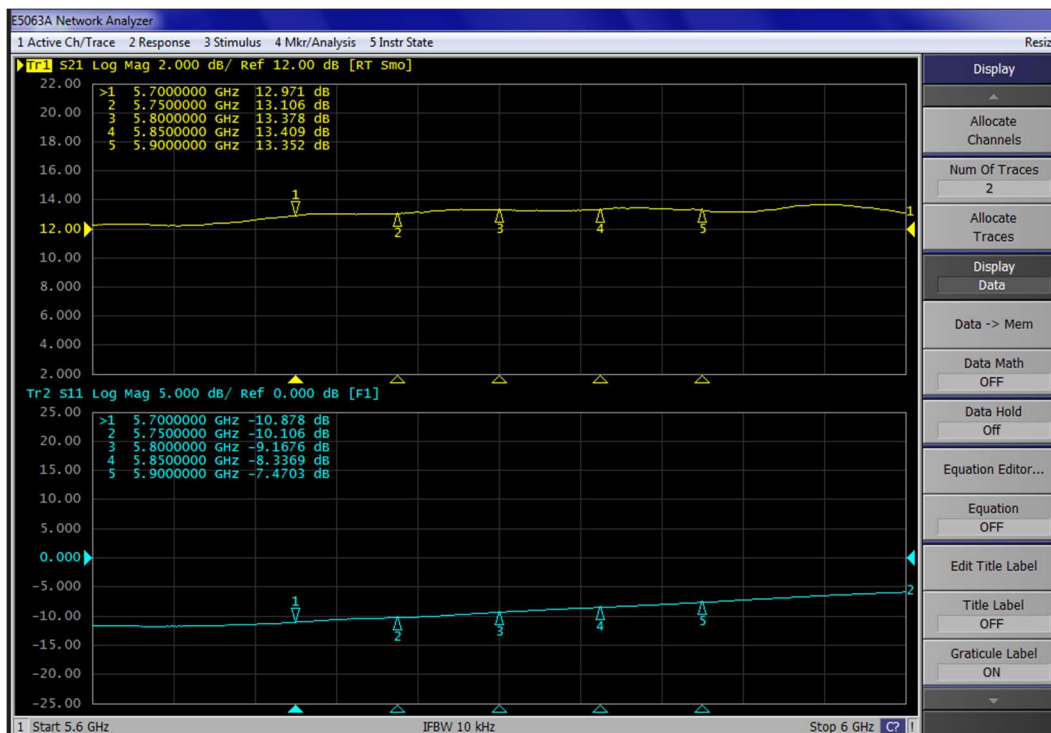
Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = -8\text{V}$; $I_{DS} = 25.2\text{mA}$	V_{DSS}	150			V
Gate Threshold Voltage	$V_{DS} = 28\text{V}$, $I_D = 25.2\text{mA}$	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	$V_{DS} = 28\text{V}$, $I_{DS} = 200\text{mA}$, Measured in Functional Test	$V_{GS(Q)}$		-3.16		V

Typical performance

5.7-5.9GHz

Figure 2: Small signal gain and return loss Vs Frequency

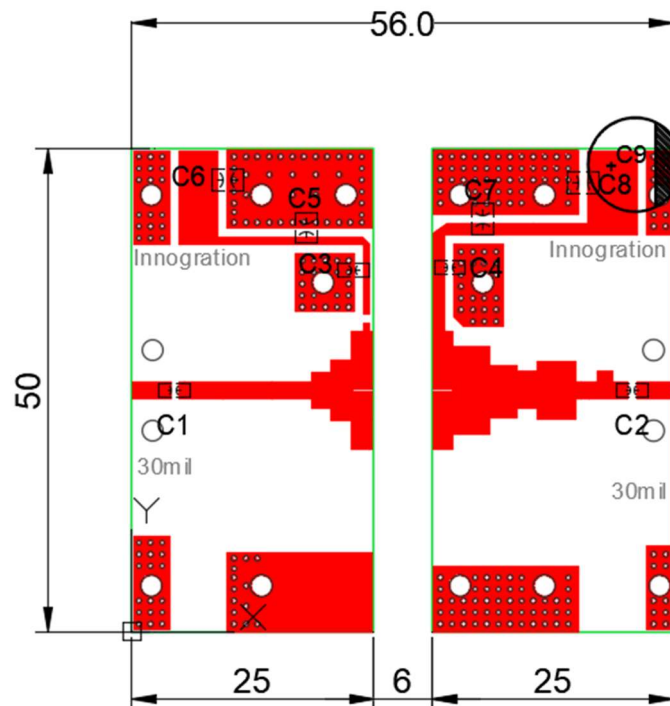
$V_{ds} = 28\text{V}$, $I_{dq} = 200\text{mA}$, input power = 0dBm



STAH58095F4C GaN TRANSISTOR

Document Number:
STAH58095F4C
Preliminary Datasheet V1.0

Figure 3: Picture and Bill of materials of 5.7-5.9GHz wide band application circuit
(Layout Gerber file upon request)



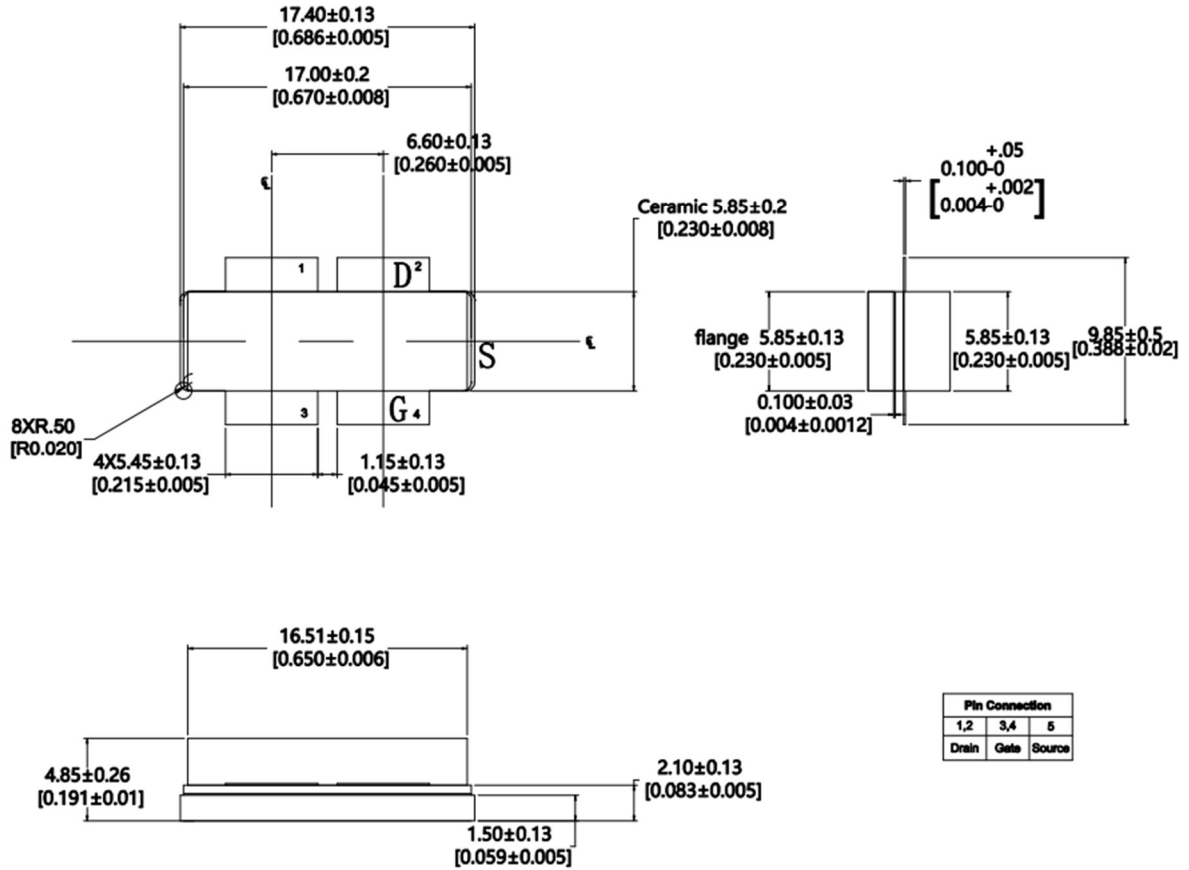
Component	Description	Suggestion
C9	470uF/63V	
C5-C8	10uF	1210
C1-C4	3pF	MQ300805COG2E3R0BNDR
R1	Chip Resistor, 10Ω	0805
PCB	Rogers 4350B, Er = 3.48, thickness 30 mils, 1oz copper	

STA58095F4C GaN TRANSISTOR

Document Number:
STA58095F4C
Preliminary Datasheet V1.0

Package Outline

Flangeless ceramic package; 4 leads



OUTLINE VERSION	REFERENCE			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
PKG-LBS					07/31/2023

Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/8/18	V1.0	Preliminary Datasheet Creation from NX5814H

Application data based on YHG-23-17